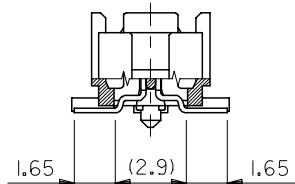
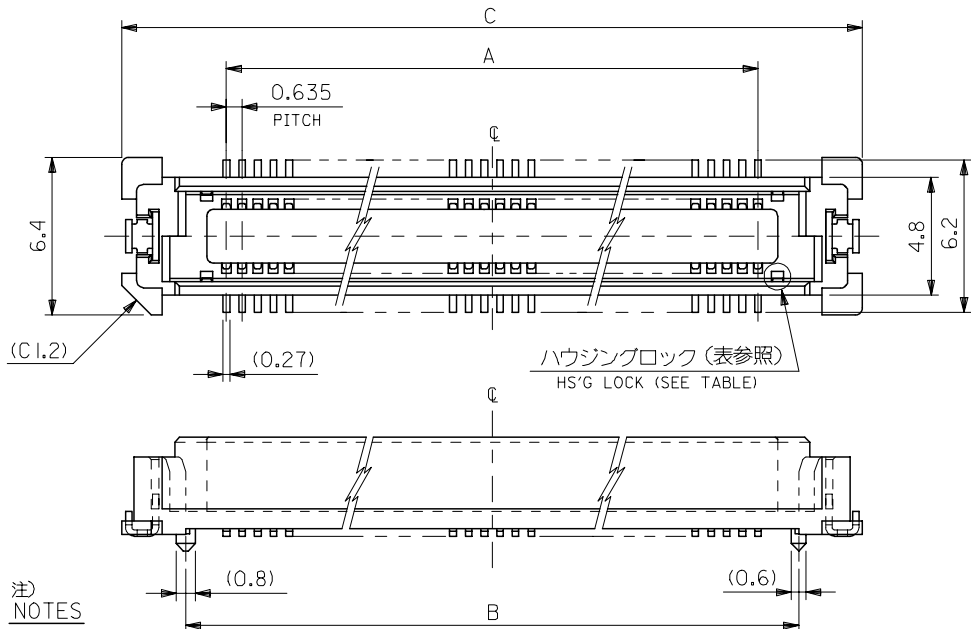
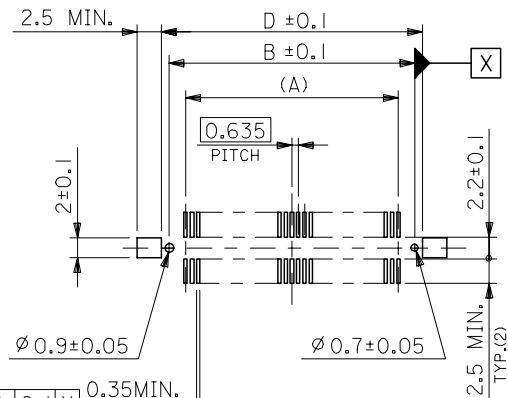
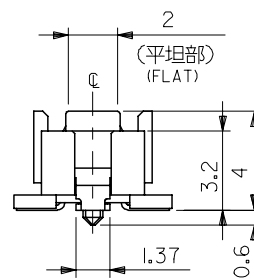


10 9 8 7 6 5 4 3 2 1



半田付け部詳細図
DETAIL FOR SOLDERING AREA



推奨基板寸法
RECOMMENDED PCB PATTERN LAYOUT
(SCALE:2-1)

注) NOTES

- 材質 MATERIAL
ハウジング : ガラス入りLCP、白色、UL94V-0
HOUSING: LIQUID CRYSTAL POLYMER, GLASS FILLED, WHITE, UL94V-0
ターミナル : 銅合金 (t=0.2)
TERMINAL: COPPER ALLOY
補強金具 : 銅合金 (t=0.25)
FITTING NAIL: COPPER ALLOY
- メッキ仕様 PLATING
ターミナル: 接点部 : 金メッキ 0.25 µmMIN.
TERMINAL: CONTACT AREA: GOLD 0.25 MICROMETER MINIMUM
半田付け部 : 錫メッキ 2.0 µmMIN.
SOLDER TAIL AREA: TIN 2.0 MICROMETER MINIMUM
下地メッキ : ニッケルメッキ 2.0 µmMIN.
UNDER-PLATING: NICKEL 2.0 MICROMETER MINIMUM
補強金具: 銅メッキ 1.0 µmMIN.
FITTING NAIL: TIN 1.0 MICROMETER MINIMUM
下地メッキ : ニッケルメッキ 1.0 µmMIN.
UNDER-PLATING: NICKEL 1.0 MICROMETER MINIMUM
- テールのバラツキ寸法
TAIL COPLANARITY
テール及び金具の平坦度は、0.1以下とする。
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1 MAXIMUM.
- エンボス対応済みの極数については、SD-52760-014を参照下さい。
FOR THE EMBOSSED PACKAGE PRODUCTS, SEE SD-52760-014.

- 本製品は52760-***Oの鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 52760-***O.

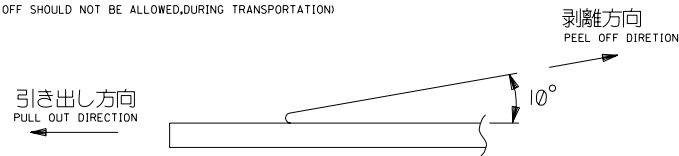
10 mm	53553 SERIES
9 mm	53552 SERIES
8 mm	53551 SERIES
7 mm	53481 SERIES
6 mm	53467 SERIES
5 mm	53475 SERIES
基板間寸法 STACKING HEIGHT	嵌合相手 TO BE MATED WITH

無し NO	80.47	84.07	78.87	75.565	—	52760-2479	52760-2470	240	—
	67.77	71.37	66.17	62.865	—	-2079	-2070	200	○
	61.42	65.02	59.82	56.515	—	-1879	-1870	180	○
	55.07	58.67	53.47	50.165	—	-1679	-1670	160	○
	48.72	52.32	47.12	43.815	—	-1479	-1470	140	○
	42.37	45.97	40.77	37.465	—	-1279	-1270	120	○
	36.02	39.62	34.42	31.115	52760-1078	-1079	-1070	100	○
	32.85	36.45	31.25	27.94	—	-0978	-0979	90	○
	29.67	33.27	28.07	24.765	—	-0878	-0879	80	○
	26.5	30.1	24.9	21.59	—	-0778	-0779	70	○
有り YES	25.86	29.43	24.26	20.955	—	-6878	-6879	68	○
	23.32	26.92	21.72	18.415	—	-0678	-0679	60	○
	20.15	23.75	18.55	15.24	—	-0578	-0579	50	○
	16.97	20.57	15.37	12.065	—	-0478	-0479	40	○
	13.8	17.4	12.2	8.89	—	-0378	-0379	30	○
	10.62	14.22	9.02	5.715	52760-0278	52760-0279	52760-0270	20	○
					エンボス極数 EMBOSSED PACKAGING	スティック極数 STICK PACKAGING	梱包 PACKAGING	製品番号 MATERIAL NO.	極数 CKT. NO.
								2760-***70	100
ハウジングロック HSG LOCK	D	C	B	A					

REVISED EC NO: J2007-0439 DRWN:MABE1 2006/08/22 CHKD:KTOYODA 2006/08/25 APPR:NUKITA 2006/09/05 A	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNIT'S METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY Y. WADA	DATE '04/02/26	TITLE 0.635 PITCH B-T0-B S/T REC. HSG ASSY -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY M. SASAO	DATE '04/02/26					
		30 OVER	±0.3	APPROVED BY M. SASAO	DATE '04/02/26					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-52760-013		1 OF 1		
	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

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6. 本製品は52760-***8の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 52760-***8.



EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	RELEASED EC NO. J2004-2690 DRWN: Y.WADA '04/02/26 CHK: M.SASAO '04/02/26 APPR: M.SASAO '04/02/26	DESCRIPTION	MATERIAL 材料	注) 参照 SEE NOTES	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE —#—	MODEL NO. DESIGN UNITS ☑mm ☐INCH	52760-**78 THIRD ANGLE PROJECTION ☉	DIMENSIONS: ☐mm INCH mm ☑mm ONLY	SHT REVISE ON CAD ONLY	REV
						FINISH 仕上付	注) 参照 SEE NOTES	10 UNDER 未満	±0.2	DRAWN BY & DATE Y.WADA '04/02/26	TITLE: 52760-**70 TAPING PACKAGE -LEAD FREE-			
						WIRE RANGE 適用電線範囲	—#—	ANGLE 角度	±3°	CAD FILENAME SD-52760-014.S01		MATERIAL NO. SEE CHART	DRAWING NO. SD-52760-014	SHEET NO. 1 OF 2
								INS. RANGE 被覆外径	—#—	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.				SIZE B

